LIN Doc #: 1840

# LINFINITY MICROELECTRONICS

THE INFINITE POWER OF INNOVATION

# UC184xA/284xA/384xA

## CURRENT MODE PWM CONTROLLER

PRODUCTION DATA SHEET

## DESCRIPTION

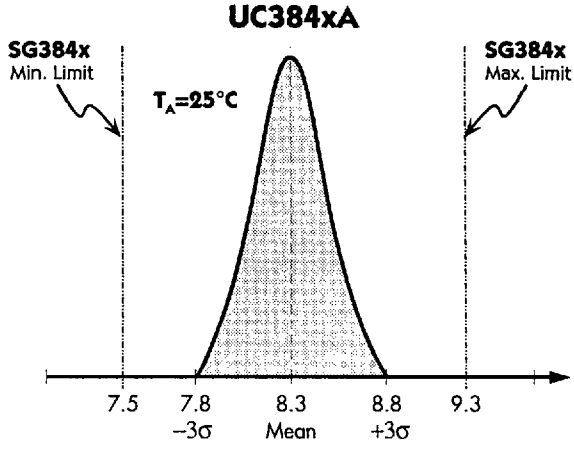
The UC184xA family of control IC's provides all the necessary features to implement off-line fixed-frequency, current-mode switching power supplies with a minimum of external components. The current mode architecture demonstrates improved load regulation, pulse-by-pulse current limiting and inherent protection of the power supply output switch. The IC includes: A bandgap reference trimmed to ±1% accuracy, an error amplifier, a current sense comparator with internal clamp to 1V, a high current totem pole output stage for fast switching of power mosfet's, and an externally programmable oscillator to set frequency and maximum duty cycle. The under-voltage lock-out is designed to operate with 250µA typ. start-up current, allowing an efficient bootstrap supply voltage design. Available options for this family of products, such as start-up voltage hysteresis and duty cycle, are summarized below in the Available Options section. The UC184xA family of control IC's is also available in 14-pin SOIC package which makes the Power Output Stage Collector and Ground pins available.

## KEY FEATURES

- **LOW START-UP CURRENT.** (0.5mA max.)
- **TRIMMED OSCILLATOR DISCHARGE CURRENT.** (See Product Highlight)
- OPTIMIZED FOR OFF-LINE AND DC-TO-DC CONVERTERS.
- AUTOMATIC FEED FORWARD COMPENSATION.
- PULSE-BY-PULSE CURRENT LIMITING.
- ENHANCED LOAD RESPONSE CHARACTERISTICS.
- UNDER-VOLTAGE LOCKOUT WITH HYSTERESIS.
- DOUBLE PULSE SUPPRESSION.
- HIGH-CURRENT TOTEM POLE OUTPUT.
- INTERNALLY TRIMMED BANDGAP REFERENCE.
- 500KHz OPERATION.
- LOW $R_O$ ERROR AMPLIFIER.

## PRODUCT HIGHLIGHT

COMPARISON OF UC384xA VS. SG384x DISCHARGE CURRENT




**Discharge Current Distribution - mA**

## APPLICATIONS

- ECONOMICAL OFF-LINE FLYBACK OR FORWARD CONVERTERS.
- DC-DC BUCK OR BOOST CONVERTERS.
- LOW COST DC MOTOR CONTROL.

AVAILABLE OPTIONS

| Part # | Start-Up Voltage | Hysteresis | Max. Duty Cycle |
|---|---|---|---|
| UCx842A | 16V | 6V | <100% |
| UCx843A | 8.4V | 0.8V | <100% |
| UCx844A | 16V | 6V | <50% |
| UCx845A | 8.4V | 0.8V | <50% |

## PACKAGE ORDER INFORMATION

| $T_A$ (°C) | M Plastic DIP 8-pin | DM Plastic SOIC 8-pin | D Plastic SOIC 14-pin | Y Ceramic DIP 8-pin |
|---|---|---|---|---|
| 0 to 70 | UC384xAM | UC384xADM | UC384xAD | — |
| -40 to 85 | UC284xAM | UC284xADM | UC284xAD | UC284xAY |
| -55 to 125 | — | — | — | UC184xAY |

Note: All surface-mount packages are available in Tape & Reel. Append the letter "T" to part number. (i.e. UC3842ADMT)



FOR FURTHER INFORMATION CALL (714) 898-8121

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## ABSOLUTE MAXIMUM RATINGS (Note 1)

Supply Voltage (Low Impedance Source) ($V_{CC}$) ..... 30V
Supply Voltage ($I_{CC}$ < 30mA) ..... Self Limiting
Output Current ..... ±1A
Output Energy (Capacitive Load) ..... 5µJ
Analog Inputs ($V_{FB}$ & $I_{SENSE}$) ..... -0.3V to +6.3V
Error Amp Output Sink Current ..... 10mA
Power Dissipation at $T_A$ = 25°C (M Package) ..... 1W
Storage Temperature Range ..... -65°C to +150°C
Lead Temperature (Soldering, 10 Seconds) ..... 300°C

Note 1. Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of the specified terminal. Pin numbers refer to DIL packages only.

## THERMAL DATA

**M PACKAGE:**

| | |
|---|---|
| THERMAL RESISTANCE-JUNCTION TO AMBIENT, $\theta_{JA}$ | 95°C/W |

**DM PACKAGE:**

| | |
|---|---|
| THERMAL RESISTANCE-JUNCTION TO AMBIENT, $\theta_{JA}$ | 165°C/W |

**D PACKAGE:**

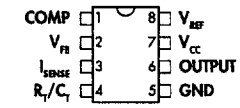
| | |
|---|---|
| THERMAL RESISTANCE-JUNCTION TO AMBIENT, $\theta_{JA}$ | 120°C/W |

**Y PACKAGE:**

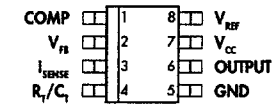
| | |
|---|---|
| THERMAL RESISTANCE-JUNCTION TO AMBIENT, $\theta_{JA}$ | 130°C/W |

Junction Temperature Calculation: $T_J = T_A + (P_D \times \theta_{JA})$.
The $\theta_{JA}$ numbers are guidelines for the thermal performance of the device/pc-board system.
All of the above assume no ambient airflow

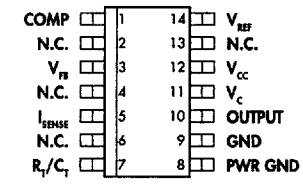
## PACKAGE PIN OUTS




**M & Y PACKAGE**
(Top View)




**DM PACKAGE**
(Top View)




**D PACKAGE**
(Top View)

## ELECTRICAL CHARACTERISTICS

(Unless otherwise specified, these specifications apply over the operating ambient temperatures for UC384xA with $0°C \le T_A \le 70°C$, UC284xA with $-40°C \le T_A \le 85°C$, UC184xA with $-55°C \le T_A \le 125°C$; $V_{CC}$=15V; $R_T$=10K; $C_T$=3.3nF. Low duty cycle pulse testing techniques are used which maintains junction and case temperatures equal to the ambient temperature.)

| Parameter | Symbol | Test Conditions | UC184xA/284xA | | | UC384xA | | | Units |
|---|---|---|---|---|---|---|---|---|---|
| | | | Min. | Typ. | Max. | Min. | Typ. | Max. | |
| **Reference Section** | | | | | | | | | |
| Output Voltage | $V_{REF}$ | $T_J$ = 25°C, $I_L$ = 1mA | 4.95 | 5.00 | 5.05 | 4.90 | 5.00 | 5.10 | V |
| Line Regulation | | $12 \le V_{IN} \le 25V$ | | 6 | 20 | | 6 | 20 | mV |
| Load Regulation | | $1 \le I_O \le 20mA$ | | 6 | 25 | | 6 | 25 | mV |
| Temperature Stability (Note 2 & 7) | | | | 0.2 | 0.4 | | 0.2 | 0.4 | mV/°C |
| Total Output Variation | | Over Line, Load, and Temperature | 4.9 | | 5.1 | 4.82 | | 5.18 | V |
| Output Noise Voltage (Note 2) | $V_N$ | $10Hz \le f \le 10kHz$, $T_J$ = 25°C | | 50 | | | 50 | | µV |
| Long Term Stability (Note 2) | | $T_A$ = 125°C, t = 1000hrs | | 5 | 25 | | 5 | 25 | mV |
| Output Short Circuit Current | $I_{SC}$ | | -30 | -100 | -180 | -30 | -100 | -180 | mA |
| **Oscillator Section** | | | | | | | | | |
| Initial Accuracy (Note 6) | | $T_J$ = 25°C | 47 | 52 | 57 | 47 | 52 | 57 | kHz |
| Voltage Stability | | $12 \le V_{CC} \le 25V$ | | 0.2 | 1 | | 0.2 | 1 | % |
| Temperature Stability (Note 2) | | $T_{MIN} \le T_A \le T_{MAX}$ | | 5 | | | 5 | | % |
| Amplitude (Note 2) | | | | 1.7 | | | 1.7 | | V |
| Discharge Current | | $T_J$ = 25°C, $V_{PIN\,4}$ = 2V | 7.8 | 8.3 | 8.8 | 7.8 | 8.3 | 8.8 | mA |
| | | $V_{PIN\,4}$ = 2V, $T_{MIN} \le T_A \le T_{MAX}$ | 7.5 | | 8.8 | 7.6 | | 8.8 | mA |
| **Error Amp Section** | | | | | | | | | |
| Input Voltage | | $V_{PIN\,1}$ = 2.5V | 2.45 | 2.50 | 2.55 | 2.42 | 2.50 | 2.58 | V |
| Input Bias Current | $I_B$ | | | -0.3 | -1 | | -0.3 | -2 | µA |
| Open Loop Gain | $A_{VOL}$ | $2 \le V_O \le 4V$ | 65 | 90 | | 65 | 90 | | dB |
| Unity Gain Bandwidth (Note 2) | UGBW | $T_j$ = 25°C | 0.7 | 1 | | 0.7 | 1 | | MHz |
| Power Supply Rejection Ratio (Note 3) | PSRR | $12 \le V_{CC} \le 25V$ | 60 | 70 | | 60 | 70 | | dB |
| Output Sink Current | $I_{OL}$ | $V_{PIN\,2}$ = 2.7V, $V_{PIN\,1}$ = 1.1V | 2 | 6 | | 2 | 6 | | mA |
| Output Source Current | $I_{OH}$ | $V_{PIN\,2}$ = 2.3V, $V_{PIN\,1}$ = 5V | -0.5 | -0.8 | | -0.5 | -0.8 | | mA |
| Output Voltage High Level | $V_{OH}$ | $V_{PIN\,2}$ = 2.3V, $R_L$ = 15K to ground | 5 | 6 | | 5 | 6 | | V |
| Output Voltage Low Level | $V_{OL}$ | $V_{PIN\,2}$ = 2.7V, $R_L$ = 15K to $V_{REF}$ | | 0.7 | 1.1 | | 0.7 | 1.1 | V |
| **Current Sense Section** | | | | | | | | | |
| Gain (Note 3 & 4) | $A_{VOL}$ | | 2.85 | 3 | 3.15 | 2.85 | 3 | 3.15 | V/V |
| Maximum Input Signal (Note 3) | | $V_{PIN\,1}$ = 5V | 0.9 | 1 | 1.1 | 0.9 | 1 | 1.1 | V |
| Power Supply Rejection Ratio (Note 3) | PSRR | $12 \le V_{CC} \le 25V$ | | 70 | | | 70 | | dB |
| Input Bias Current | $I_B$ | | | -2 | -10 | | -2 | -10 | µA |
| Delay to Output (Note 2) | $T_{pd}$ | $V_{PIN\,3}$ = 0 to 2V | | 150 | 300 | | 150 | 300 | ns |
| **Output Section** | | | | | | | | | |
| Output Low Level | $V_{OL}$ | $I_{SINK}$ = 20mA | | 0.1 | 0.4 | | 0.1 | 0.4 | V |
| | | $I_{SINK}$ = 200mA | | 1.5 | 2.2 | | 1.5 | 2.2 | V |
| Output High Level | $V_{OH}$ | $I_{SOURCE}$ = 20mA | 13 | 13.5 | | 13 | 13.5 | | V |
| | | $I_{SOURCE}$ = 200mA | 12 | 13.5 | | 12 | 13.5 | | V |
| Rise Time (Note 2) | $T_R$ | $T_J$ = 25°C, $C_L$ = 1nF | | 50 | 150 | | 50 | 150 | ns |
| Fall Time (Note 2) | $T_F$ | $T_J$ = 25°C, $C_L$ = 1nF | | 50 | 150 | | 50 | 150 | ns |
| UVLO Saturation | $V_{SAT}$ | $V_{CC}$ = 5V, $I_{SINK}$ = 10mA | | 0.7 | 1.2 | | 0.7 | 1.2 | V |

*(Electrical Characteristics continue next page.)*

## ELECTRICAL CHARACTERISTICS (Con't.)

| Parameter | Symbol | Test Conditions | UC184xA/284xA | | | UC384xA | | | Units |
|---|---|---|---|---|---|---|---|---|---|
| | | | Min. | Typ. | Max. | Min. | Typ. | Max. | |
| **Under-Voltage Lockout Section** | | | | | | | | | |
| Start Threshold | | x842A/4A | 15 | 16 | 17 | 14.5 | 16 | 17.5 | V |
| | | x843A/5A | 7.8 | 8.4 | 9.0 | 7.8 | 8.4 | 9.0 | V |
| Min. Operation Voltage After Turn-On | | x842A/4A | 9 | 10 | 11 | 8.5 | 10 | 11.5 | V |
| | | x843A/5A | 7.0 | 7.6 | 8.2 | 7.0 | 7.6 | 8.2 | V |
| **PWM Section** | | | | | | | | | |
| Maximum Duty Cycle | | x842A/3A | 94 | 96 | 100 | 94 | 96 | 100 | % |
| | | x844A/5A | 47 | 48 | 50 | 47 | 48 | 50 | % |
| Minimum Duty Cycle | | | | | 0 | | | 0 | % |
| **Total Standby Section** | | | | | | | | | |
| Start-Up Current | | | | 0.3 | 0.5 | | 0.3 | 0.5 | mA |
| Operating Supply Current | $I_{CC}$ | | | 11 | 17 | | 11 | 17 | mA |
| Zener Voltage | $V_Z$ | $I_{CC}$ = 25mA | 30 | 35 | | 30 | 35 | | V |

Notes: 2. These parameters, although guaranteed, are not 100% tested in production.

3. Parameter measured at trip point of latch with $V_{VFB}$ = 0.

4. Gain defined as: $A_{VOL} = \frac{\Delta V_{COMP}}{\Delta V_{ISENSE}}$ ; $0 \le V_{ISENSE} \le 0.8V$.

5. Adjust $V_{CC}$ above the start threshold before setting at 15V.

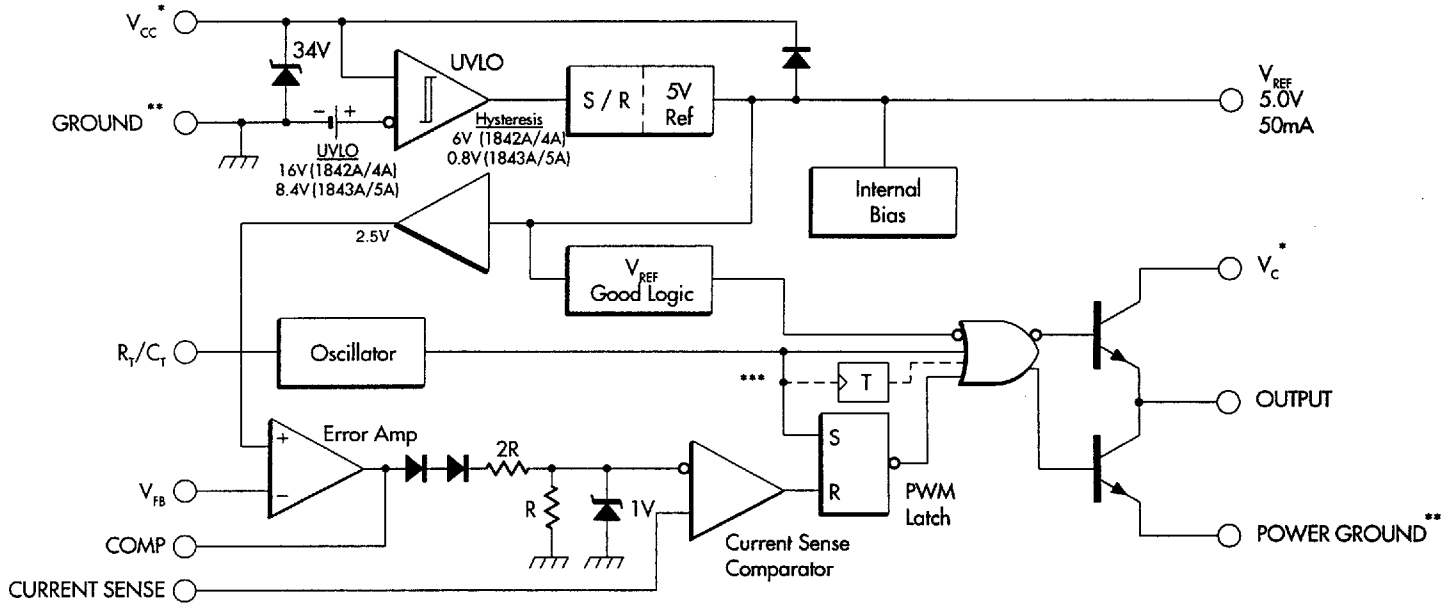
6. Output frequency equals oscillator frequency for the UC1842A and UC1843A. Output frequency is one half oscillator frequency for the UC1844A and UC1845A.

7. "Temperature stability, sometimes referred to as average temperature coefficient, is described by the equation:

$$\text{Temp Stability} = \frac{V_{REF}\,(\text{max.}) - V_{REF}\,(\text{min.})}{T_J\,(\text{max.}) - T_J\,(\text{min.})}$$

$V_{REF}$ (max.) & $V_{REF}$ (min.) are the maximum & minimum reference voltage measured over the appropriate temperature range. Note that the extremes in voltage do not necessarily occur at the extremes in temperature."

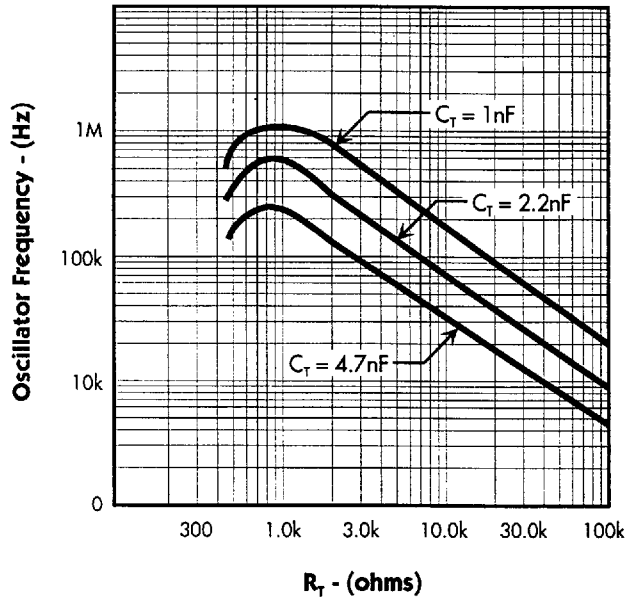
## BLOCK DIAGRAM

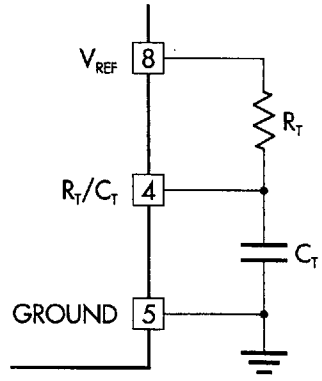



* - $V_{CC}$ and $V_C$ are internally connected for 8 pin packages.
** - POWER GROUND and GROUND are internally connected for 8 pin packages.
*** - Toggle flip flop used only in x844A and x845A series.

## CHARACTERISTIC CURVES

**FIGURE 1.** — OSCILLATOR FREQUENCY vs. TIMING RESISTOR

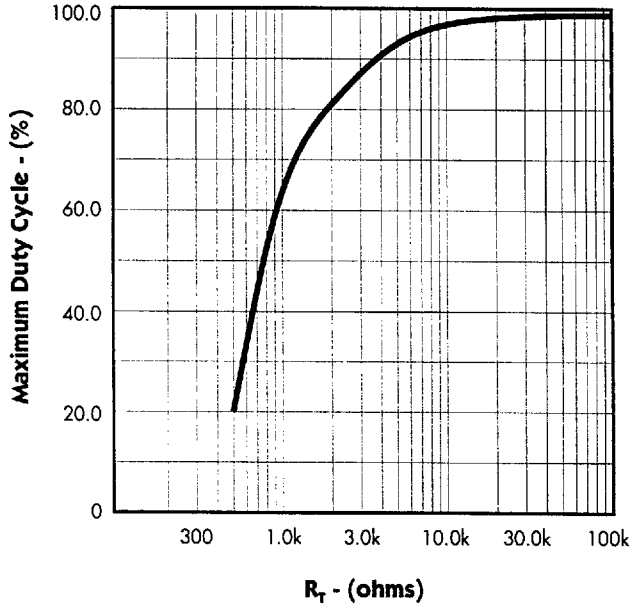



For $R_T > 5k$, $f \approx \frac{1.72}{R_T C_T}$

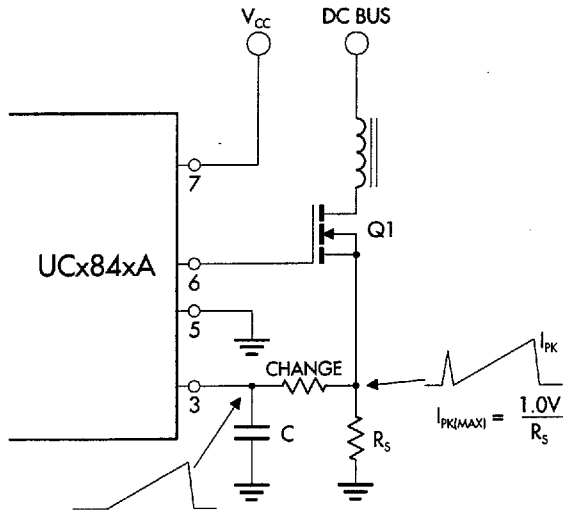
Note: Output drive frequency is half the oscillator frequency for the UCx844A/5A devices.

**FIGURE 2.** — MAXIMUM DUTY CYCLE vs. TIMING RESISTOR



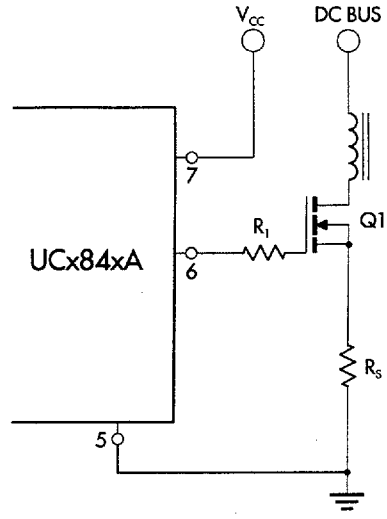
## TYPICAL APPLICATION CIRCUITS

**FIGURE 3.** — CURRENT SENSE SPIKE SUPPRESSION



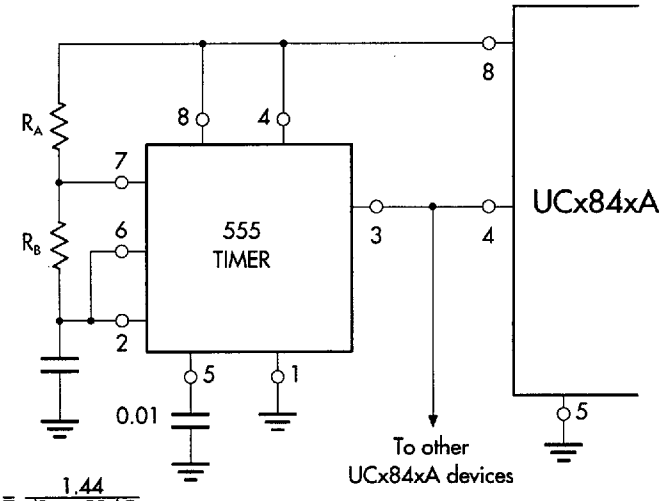

The RC low pass filter will eliminate the leading edge current spike caused by parasitics of Power MOSFET.

**FIGURE 4.** — MOSFET PARASITIC OSCILLATIONS




A resistor ($R_1$) in series with the MOSFET gate will reduce overshoot & ringing caused by the MOSFET input capacitance and any inductance in series with the gate drive. (Note: It is very important to have a low inductance ground path to insure correct operation of the I.C. This can be done by making the ground paths as short and as wide as possible.)

**FIGURE 5.** — EXTERNAL DUTY CYCLE CLAMP AND MULTI-UNIT SYNCHRONIZATION



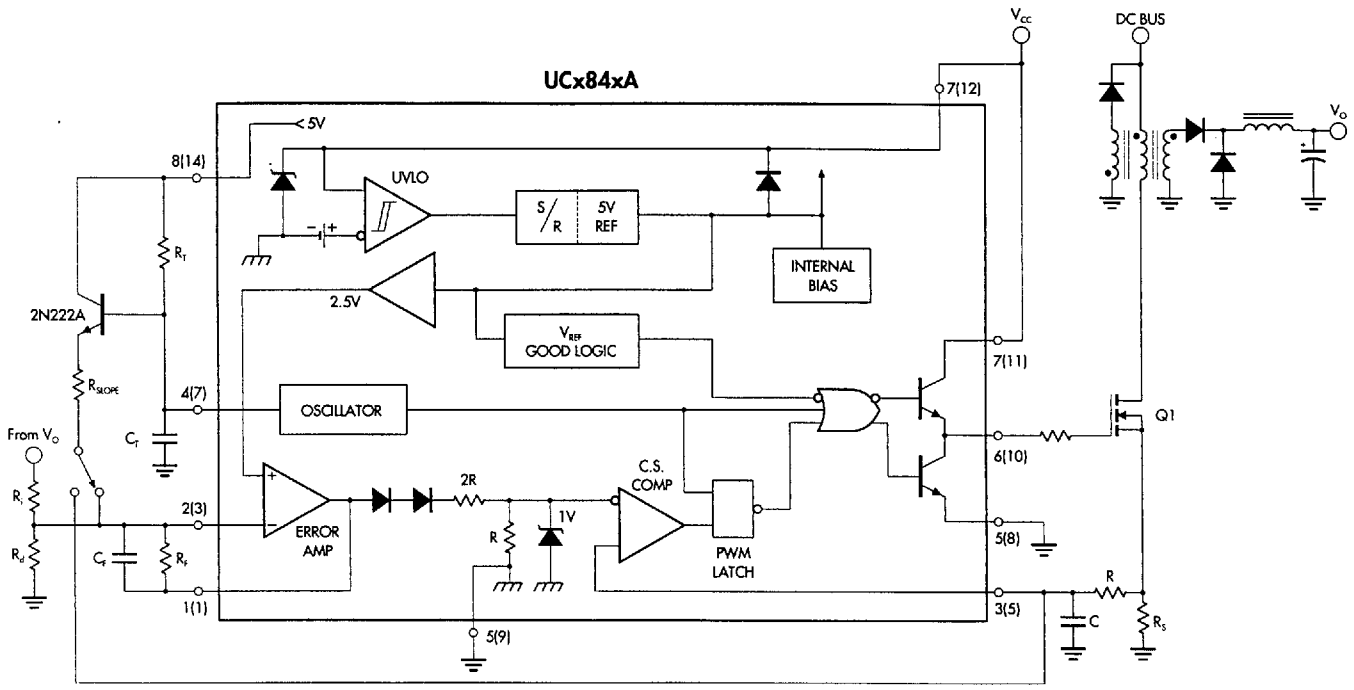

$$f = \frac{1.44}{(R_A + 2R_B)C}$$

$$f = \frac{R_B}{R_A + 2R_B}$$

Precision duty cycle limiting as well as synchronizing several parts is possible with the above circuitry.

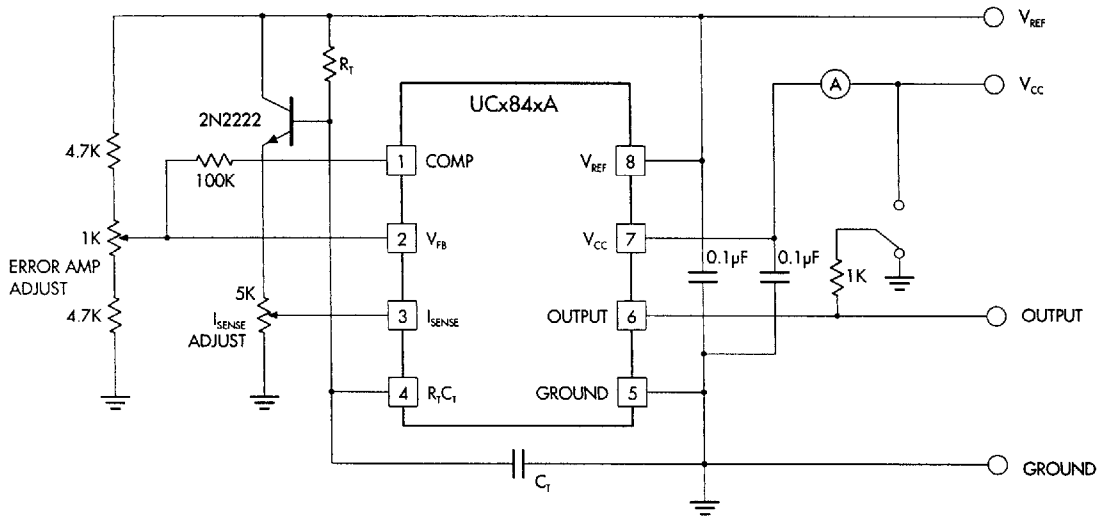
## TYPICAL APPLICATION CIRCUITS (continued)

**FIGURE 6.** — SLOPE COMPENSATION




Due to inherent instability of current mode converters running above 50% duty cycle, slope compensation should be added to either the current sense pin or the error amplifier. Figure 6 shows a typical slope compensation technique.

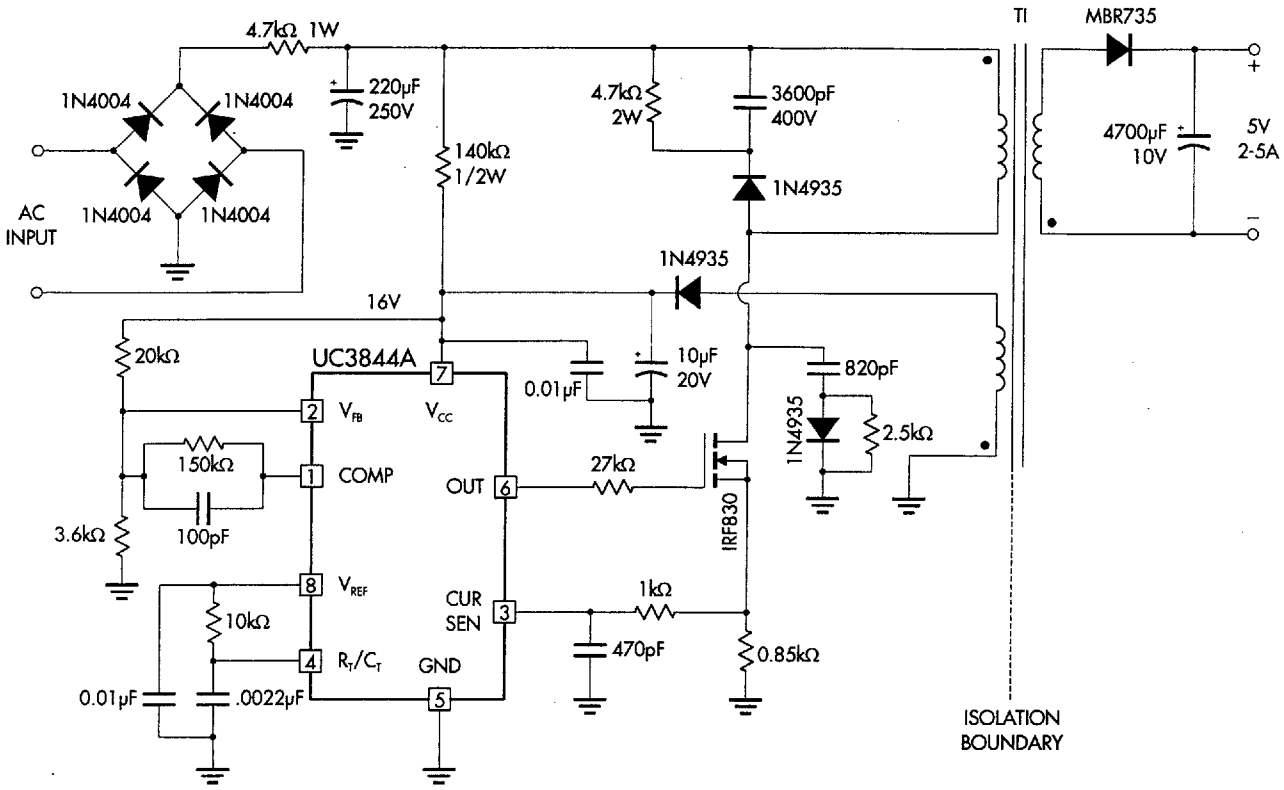
**FIGURE 7.** — OPEN LOOP LABORATORY FIXTURE




High peak currents associated with capacitive loads necessitate careful grounding techniques. Timing and bypass capacitors should be connected to pin 5 in a single point ground. The transistor and 5k potentiometer are used to sample the oscillator waveform and apply an adjustable ramp to pin 3.

## TYPICAL APPLICATION CIRCUITS (continued)

**FIGURE 8.** — OFF-LINE FLYBACK REGULATOR




### SPECIFICATIONS

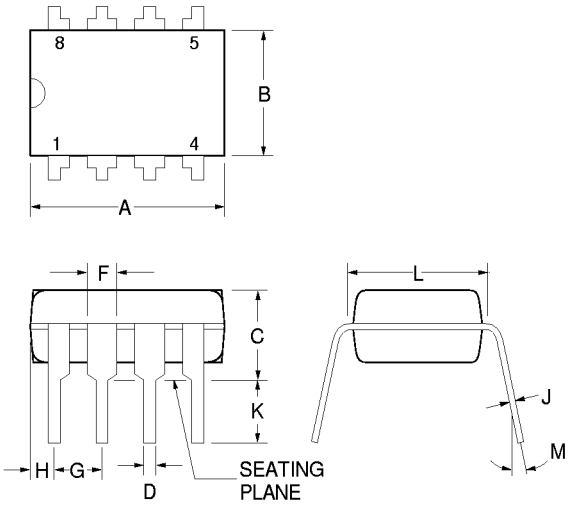
| | |
|---|---|
| Input line voltage: | 90VAC to 130VAC |
| Input frequency: | 50 or 60Hz |
| Switching frequency: | 40KHz ±10% |
| Output power: | 25W maximum |
| Output voltage: | 5V +5% |
| Output current: | 2 to 5A |
| Line regulation: | 0.01%/V |
| Load regulation: | 8%/A* |
| Efficiency @ 25 Watts, | |
| $V_{IN}$ = 90VAC: | 70% |
| $V_{IN}$ = 130VAC: | 65% |
| Output short-circuit current: | 2.5Amp average |

* This circuit uses a low-cost feedback scheme in which the DC voltage developed from the primary-side control winding is sensed by the UC3844A error amplifier. Load regulation is therefore dependent on the coupling between secondary and control windings, and on transformer leakage inductance.

# Package Information

## MECHANICAL DIMENSIONS

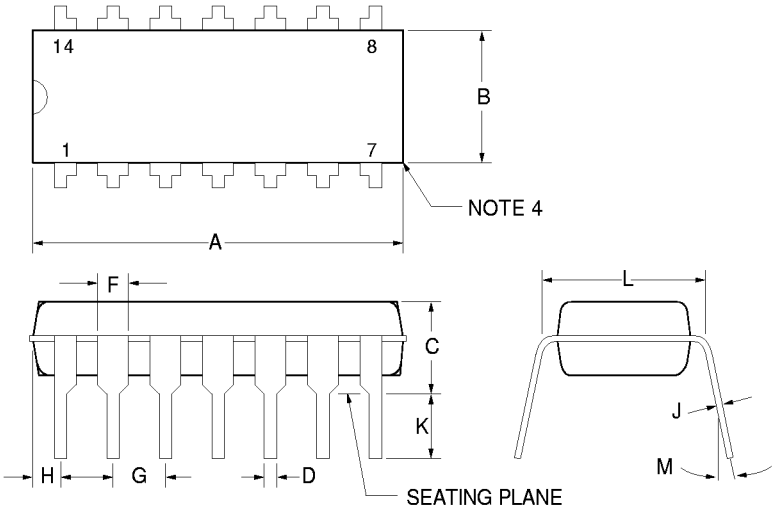
## M 8-Pin Plastic Mini-Dip




| DIM | Millimeters | | Inches | |
|---|---|---|---|---|
| | MIN | MAX | MIN | MAX |
| A | | 10.16 | | 0.400 |
| B | 6.10 | 6.60 | 0.240 | 0.260 |
| C | | 5.08 | | 0.200 |
| D | 0.38 | 0.51 | 0.015 | 0.020 |
| F | 0.76 | 1.52 | 0.030 | 0.060 |
| G | 2.54 BSC | | 0.100 BSC | |
| H | 0.76 | 1.27 | 0.030 | 0.050 |
| J | 0.20 | 0.38 | 0.008 | 0.015 |
| K | 3.18 | | 0.125 | |
| L | 7.62 BSC | | 0.300 BSC | |
| M | | 15 | | 15 |

Note:
1. Dimensions do not include mold flash or protrusions; these shall not exceed 0.15mm (.006") on any side. Lead dimension shall not include solder coverage.

## N 14-Pin Plastic Dip



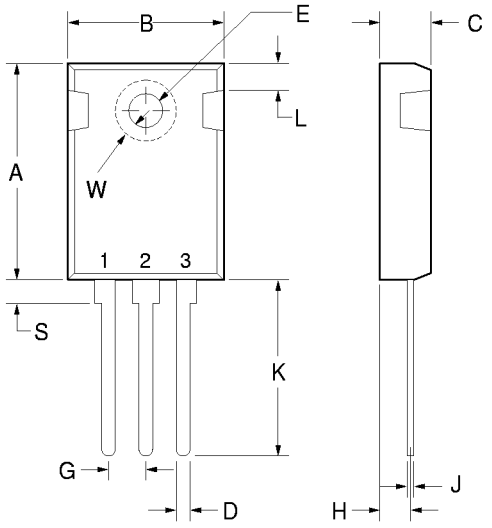

| DIM | Millimeters | | Inches | |
|---|---|---|---|---|
| | MIN | MAX | MIN | MAX |
| A | 18.54 | 20.57 | 0.730 | 0.810 |
| B | 6.09 | 6.60 | 0.240 | 0.260 |
| C | | 5.08 | | 0.200 |
| D | 0.38 | 0.51 | 0.015 | 0.020 |
| F | 0.76 | 1.52 | 0.030 | 0.060 |
| G | 2.54 BSC | | 0.100 BSC | |
| H | 1.27 | 2.28 | 0.050 | 0.090 |
| J | 0.20 | 0.38 | 0.008 | 0.015 |
| K | 3.18 | | 0.125 | |
| L | 7.62 BSC | | 0.300 BSC | |
| M | | 15 | | 15 |

Note:
1. Dimensions do not include mold flash or protrusions; these shall not exceed 0.15mm (.006") on any side. Lead dimension shall not include solder coverage.



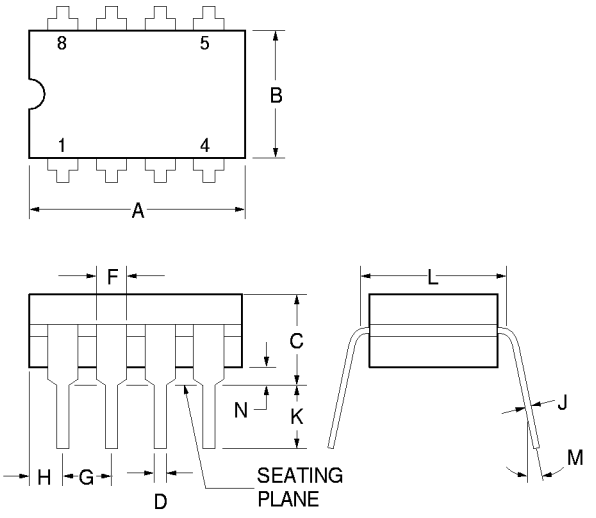
LINFINITY MICROELECTRONICS

## V 3-Pin Plastic TO-247




| DIM | Millimeters | | Inches | |
|---|---|---|---|---|
| | MIN | MAX | MIN | MAX |
| A | 20.83 | 21.34 | 0.820 | 0.840 |
| B | | 16.26 | | 0.640 |
| C | 4.93 | 5.33 | 0.190 | 0.210 |
| D | 1.02 | 1.40 | 0.040 | 0.055 |
| E | 3.18 | 3.43 | 0.125 | 0.135 |
| G | 5.46 BSC | | 0.215 BSC | |
| H | | 2.79 | | 0.110 |
| J | 0.51 | 0.71 | 0.020 | 0.028 |
| K | 19.81 | 20.32 | 0.780 | 0.800 |
| L | 3.05 | 3.56 | 0.120 | 0.140 |
| S | | 4.50 | | 0.177 |
| W | | 3.43 | | 0.135 |

## Y 8-Pin Ceramic Dip

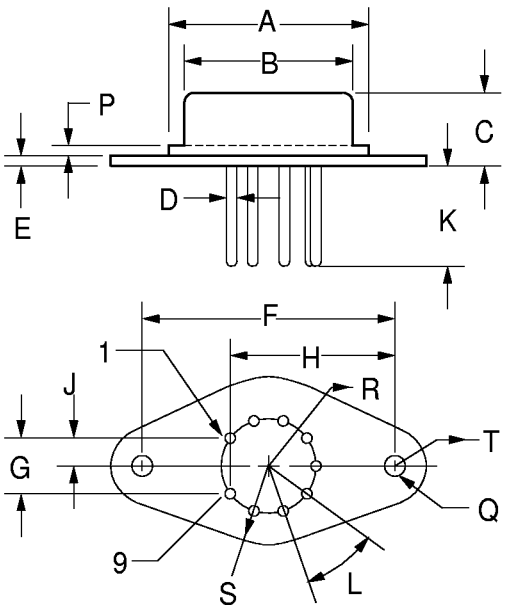



| DIM | Millimeters | | Inches | |
|---|---|---|---|---|
| | MIN | MAX | MIN | MAX |
| A | 9.91 | 10.92 | 0.390 | 0.430 |
| B | 5.59 | 7.11 | 0.220 | 0.280 |
| C | 4.32 | 5.08 | 0.170 | 0.200 |
| D | 0.38 | 0.51 | 0.015 | 0.020 |
| F | 1.02 | 1.78 | 0.040 | 0.070 |
| G | 2.54 BSC | | 0.100 BSC | |
| H | 1.14 | 1.65 | 0.045 | 0.065 |
| J | 0.20 | 0.38 | 0.008 | 0.015 |
| K | 3.18 | 4.06 | 0.125 | 0.160 |
| L | 7.37 | 7.87 | 0.290 | 0.310 |
| M | | 15 | | 15 |
| N | 0.51 | 1.02 | 0.020 | 0.040 |

# Package Information

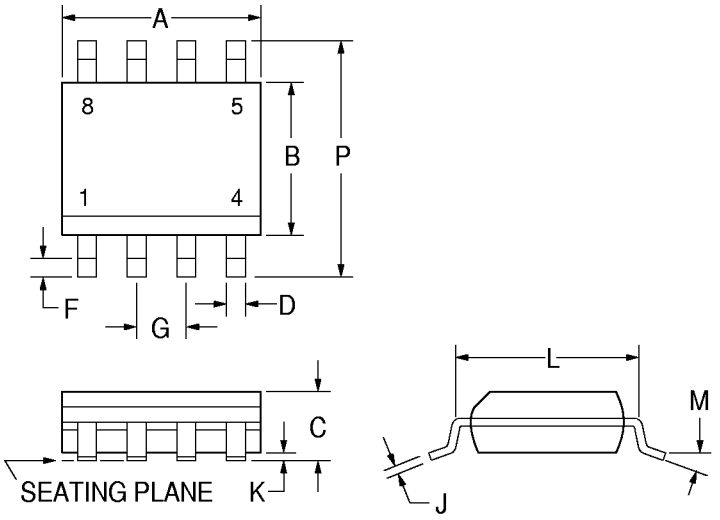
## MECHANICAL DIMENSIONS

## R 9-Pin Metal Can TO-66




| DIM | Millimeters | | Inches | |
|---|---|---|---|---|
| | MIN | MAX | MIN | MAX |
| A | | 15.75 | | 0.620 |
| B | 11.94 | 12.70 | 0.470 | 0.500 |
| C | 6.60 | 7.62 | 0.260 | 0.300 |
| D | 0.71 | 0.86 | 0.028 | 0.034 |
| E | 1.27 | 1.91 | 0.050 | 0.075 |
| F | 24.33 | 24.43 | 0.958 | 0.962 |
| G | 4.83 | 5.33 | 0.190 | 0.210 |
| H | 14.48 | 14.99 | 0.570 | 0.590 |
| J | 2.36 | 2.72 | 0.093 | 0.107 |
| K | 9.14 | 10.41 | 0.360 | 0.410 |
| L | 36 TYP | | 36 TYP | |
| P | | 0.64 | | 0.025 |
| Q | 3.61 | 3.86 | 0.142 | 0.152 |
| R | | 4.11R | | 0.162R |
| S | | 8.89R | | 0.350R |
| T | | 3.68R | | 0.145R |

## DM 8-Pin Plastic SOIC




| DIM | Millimeters | | Inches | |
|---|---|---|---|---|
| | MIN | MAX | MIN | MAX |
| A | 4.83 | 5.00 | 0.190 | 0.197 |
| B | 3.81 | 3.94 | 0.150 | 0.155 |
| C | 1.35 | 1.75 | 0.053 | 0.069 |
| D | 0.33 | 0.51 | 0.013 | 0.020 |
| F | | 0.77 | | 0.030 |
| G | 1.27 BSC | | 0.050 BSC | |
| J | 0.19 | 0.25 | 0.007 | 0.010 |
| K | 0.13 | 0.25 | 0.005 | 0.010 |
| L | 4.80 | 5.21 | 0.189 | 0.205 |
| M | | 8 | | 8 |
| P | 5.79 | 6.20 | 0.228 | 0.244 |
| *LC | | 0.10 | | 0.004 |

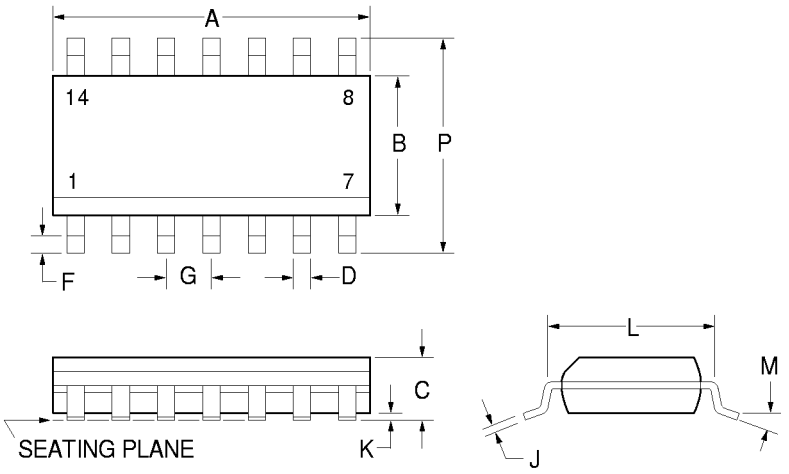
* Lead Coplanarity

Note:
1. Dimensions do not include mold flash or protrusions; these shall not exceed 0.15mm (.006") on any side. Lead dimension shall not include solder coverage.



LINFINITY MICROELECTRONICS

## D 14-Pin Plastic SOIC



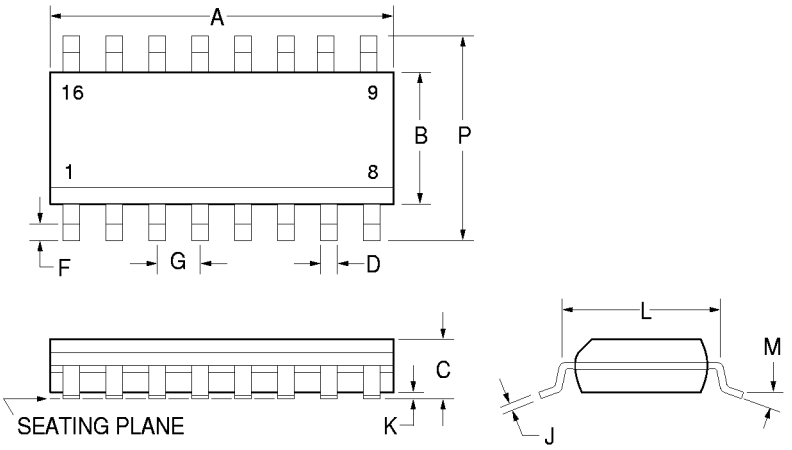

| DIM | Millimeters | | Inches | |
|---|---|---|---|---|
| | MIN | MAX | MIN | MAX |
| A | 8.54 | 8.74 | 0.336 | 0.344 |
| B | 3.81 | 3.94 | 0.150 | 0.155 |
| C | 1.35 | 1.75 | 0.053 | 0.069 |
| D | 0.33 | 0.51 | 0.013 | 0.020 |
| F | | 0.77 | | 0.030 |
| G | 1.27 BSC | | 0.050 BSC | |
| J | 0.19 | 0.25 | 0.007 | 0.010 |
| K | 0.10 | 0.25 | 0.004 | 0.010 |
| L | 4.82 | 5.21 | 0.189 | 0.205 |
| M | 0 | 8 | 0 | 8 |
| P | 5.79 | 6.20 | 0.228 | 0.244 |
| *LC | | 0.10 | | 0.004 |

* Lead Coplanarity

Note:

1. Dimensions do not include mold flash or protrusions; these shall not exceed 0.15mm (.006") on any side. Lead dimension shall not include solder coverage.

## D 16-Pin Plastic SOIC




| DIM | Millimeters | | Inches | |
|---|---|---|---|---|
| | MIN | MAX | MIN | MAX |
| A | 9.78 | 10.01 | 0.385 | 0.394 |
| B | 3.81 | 4.01 | 0.150 | 0.158 |
| C | 1.35 | 1.75 | 0.053 | 0.069 |
| D | 0.35 | 0.46 | 0.014 | 0.018 |
| F | | 0.77 | | 0.030 |
| G | 1.27 BSC | | 0.050 BSC | |
| J | 0.19 | 0.25 | 0.007 | 0.010 |
| K | 0.10 | 0.25 | 0.004 | 0.010 |
| L | 4.82 | 5.21 | 0.189 | 0.205 |
| M | 0 | 8 | 0 | 8 |
| P | 5.79 | 6.20 | 0.228 | 0.244 |
| *LC | | 0.10 | | 0.004 |

* Lead Coplanarity

Note:

1. Dimensions do not include mold flash or protrusions; these shall not exceed 0.15mm (.006") on any side. Lead dimension shall not include solder coverage.